- **Function, Pinout, and Drive Compatible With FCT and F Logic**
- **Reduced $V_{OH}$ (Typically = 3.3 V) Versions of Equivalent FCT Functions**
- **Edge-Rate Control Circuitry for Significantly Improved Noise Characteristics**
- **$I_{off}$ Supports Partial-Power-Down Mode Operation**
- **Matched Rise and Fall Times**
- **Fully Compatible With TTL Input and Output Logic Levels**
- **ESD Protection Exceeds JESD 22**
  - **2000-V Human-Body Model (A114-A)**
  - **200-V Machine Model (A115-A)**
  - **1000-V Charged-Device Model (C101)**
- **Edge-Triggered D-Type Inputs**
- **250-MHz Typical Switching Rate**
- **CY54FCT574T**
  - **32-mA Output Sink Current**
  - **12-mA Output Source Current**
- **CY74FCT574T**
  - **64-mA Output Sink Current**
  - **32-mA Output Source Current**
- **3-State Outputs**

CY54FCT574T . . . D PACKAGE
CY74FCT574T . . . Q OR SO PACKAGE
(TOP VIEW)

| | | | |
|---|---|---|---|
| $\overline{OE}$ | 1 | 20 | $V_{CC}$ |
| $D_0$ | 2 | 19 | $O_0$ |
| $D_1$ | 3 | 18 | $O_1$ |
| $D_2$ | 4 | 17 | $O_2$ |
| $D_3$ | 5 | 16 | $O_3$ |
| $D_4$ | 6 | 15 | $O_4$ |
| $D_5$ | 7 | 14 | $O_5$ |
| $D_6$ | 8 | 13 | $O_6$ |
| $D_7$ | 9 | 12 | $O_7$ |
| GND | 10 | 11 | CP |
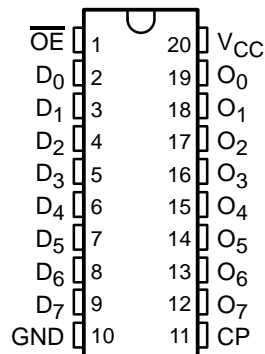
CY54FCT574T . . . L PACKAGE
(TOP VIEW)



## description

The 'FCT574T devices are high-speed, low-power, octal D-type flip-flops, featuring separate D-type inputs for each flip-flop. These devices have 3-state outputs for bus-oriented applications. A buffered clock (CP) and output-enable ($\overline{OE}$) inputs are common to all flip-flops. The 'FCT574T are identical to 'FCT374T, except for a flow-through pinout to simplify board design. The eight flip-flops in the 'FCT574T store the state of their individual D inputs that meet the setup-time and hold-time requirements on the low-to-high CP transition. When $\overline{OE}$ is low, the contents of the eight flip-flops are available at the outputs. When $\overline{OE}$ is high, the outputs are in the high-impedance state. The state of $\overline{OE}$ does not affect the state of the flip-flops.

These devices are fully specified for partial-power-down applications using $I_{off}$. The $I_{off}$ circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

**TEXAS INSTRUMENTS**

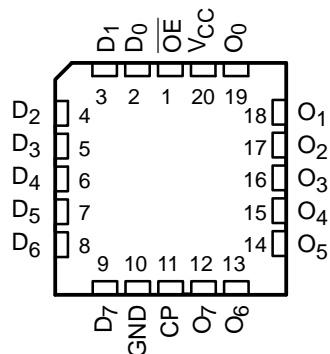# CY54FCT574T, CY74FCT574T
# 8-BIT REGISTERS
# WITH 3-STATE OUTPUTS

SCCS073 – OCTOBER 2001

## ORDERING INFORMATION

| T_A | PACKAGE† | | SPEED (ns) | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---|---|---|---|---|---|
| −40°C to 85°C | QSOP – Q | Tape and reel | 5.2 | CY74FCT574CTQCT | FCT574C |
| | SOIC – SO | Tube | 5.2 | CY74FCT574CTSOC | FCT574C |
| | | Tape and reel | 5.2 | CY74FCT574CTSOCT | |
| | QSOP – Q | Tape and reel | 6.5 | CY74FCT574ATQCT | FCT574A |
| | SOIC – SO | Tube | 6.5 | CY74FCT574ATSOC | FCT574A |
| | | Tape and reel | 6.5 | CY74FCT574ATSOCT | |
| | QSOP – Q | Tape and reel | 10 | CY74FCT574TQCT | FCT574 |
| | SOIC – SO | Tube | 10 | CY74FCT574TSOC | FCT574 |
| | | Tape and reel | 10 | CY74FCT574TSOCT | |
| −55°C to 125°C | CDIP – D | Tube | 6.2 | CY54FCT574CTDMB | |
| | CDIP – D | Tube | 7.2 | CY54FCT574ATDMB | |
| | LCC – L | Tube | 7.2 | CY54FCT574ATLMB | |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

## FUNCTION TABLE

| INPUTS | | | OUTPUT |
|---|---|---|---|
| D | CP | $\overline{OE}$ | O |
| H | ↑ | L | H |
| L | ↑ | L | L |
| X | X | H | Z |

H = High logic level, L = Low logic level,
X = Don't care, Z = High-impedance state,
↑ = Low-to-high clock transition

## logic diagram (positive logic)



To Seven Other Channels

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range to ground potential  . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . −0.5 V to 7 V
DC input voltage range  . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . −0.5 V to 7 V
DC output voltage range  . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . −0.5 V to 7 V
DC output current (maximum sink current/pin)  . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 120 mA
Package thermal impedance, $\theta_{JA}$ (see Note 1): Q package  . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 68°C/W
                                     SO package  . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 58°C/W
Ambient temperature range with power applied, $T_A$  . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . −65°C to 135°C
Storage temperature range, $T_{stg}$  . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . −65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and
  functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.
  Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTE 1:   The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 2)

|  |  | CY54FCT574T | | | CY74FCT574T | | | UNIT |
|---|---|---|---|---|---|---|---|---|
|  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| $V_{CC}$ | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| $V_{IH}$ | High-level input voltage | 2 | | | 2 | | | V |
| $V_{IL}$ | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| $I_{OH}$ | High-level output current | | | −12 | | | −32 | mA |
| $I_{OL}$ | Low-level output current | | | 32 | | | 64 | mA |
| $T_A$ | Operating free-air temperature | −55 | | 125 | −40 | | 85 | °C |

NOTE 2:   All unused inputs of the device must be held at $V_{CC}$ or GND to ensure proper device operation.

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER | TEST CONDITIONS | | CY54FCT574T | | | CY74FCT574T | | | UNIT |
|---|---|---|---|---|---|---|---|---|---|
| | | | MIN | TYP† | MAX | MIN | TYP† | MAX | |
| $V_{IK}$ | $V_{CC} = 4.5$ V, | $I_{IN} = -18$ mA | | −0.7 | −1.2 | | | | V |
| | $V_{CC} = 4.75$ V, | $I_{IN} = -18$ mA | | | | | −0.7 | −1.2 | |
| $V_{OH}$ | $V_{CC} = 4.5$ V, | $I_{OH} = -12$ mA | 2.4 | 3.3 | | | | | V |
| | $V_{CC} = 4.75$ V | $I_{OH} = -32$ mA | | | | 2 | | | |
| | | $I_{OH} = -15$ mA | | | | 2.4 | 3.3 | | |
| $V_{OL}$ | $V_{CC} = 4.5$ V, | $I_{OL} = 32$ mA | | 0.3 | 0.55 | | | | V |
| | $V_{CC} = 4.75$ V, | $I_{OL} = 64$ mA | | | | | 0.3 | 0.55 | |
| $V_{hys}$ | All inputs | | | 0.2 | | | 0.2 | | V |
| $I_I$ | $V_{CC} = 5.5$ V, | $V_{IN} = V_{CC}$ | | | 5 | | | | μA |
| | $V_{CC} = 5.25$ V, | $V_{IN} = V_{CC}$ | | | | | | 5 | |
| $I_{IH}$ | $V_{CC} = 5.5$ V, | $V_{IN} = 2.7$ V | | | ±1 | | | | μA |
| | $V_{CC} = 5.25$ V, | $V_{IN} = 2.7$ V | | | | | | ±1 | |
| $I_{IL}$ | $V_{CC} = 5.5$ V, | $V_{IN} = 0.5$ V | | | ±1 | | | | μA |
| | $V_{CC} = 5.25$ V, | $V_{IN} = 0.5$ V | | | | | | ±1 | |
| $I_{off}$ | $V_{CC} = 0$ V, | $V_{OUT} = 4.5$ V | | | ±1 | | | ±1 | μA |
| $I_{OS}$‡ | $V_{CC} = 5.5$ V, | $V_{OUT} = 0$ V | −60 | −120 | −225 | | | | mA |
| | $V_{CC} = 5.25$ V, | $V_{OUT} = 0$ V | | | | −60 | −120 | −225 | |
| $I_{OZH}$ | $V_{CC} = 5.5$ V, | $V_{IN} = 2.7$ V | | | 10 | | | | μA |
| | $V_{CC} = 5.25$ V, | $V_{IN} = 2.7$ V | | | | | | 10 | |
| $I_{OZL}$ | $V_{CC} = 5.5$ V, | $V_{IN} = 0.5$ V | | | −10 | | | | μA |
| | $V_{CC} = 5.25$ V, | $V_{IN} = 0.5$ V | | | | | | −10 | |
| $I_{CC}$ | $V_{CC} = 5.5$ V, | $V_{IN} \leq 0.2$ V, $V_{IN} \geq V_{CC} - 0.2$ V | | 0.1 | 0.2 | | | | mA |
| | $V_{CC} = 5.25$ V, | $V_{IN} \leq 0.2$ V, $V_{IN} \geq V_{CC} - 0.2$ V | | | | | 0.1 | 0.2 | |
| $\Delta I_{CC}$ | $V_{CC} = 5.5$ V, $V_{IN} = 3.4$ V§, $f_1 = 0$, Outputs open | | | 0.5 | 2 | | | | mA |
| | $V_{CC} = 5.25$ V, $V_{IN} = 3.4$ V§, $f_1 = 0$, Outputs open | | | | | | 0.5 | 2 | |

† Typical values are at $V_{CC} = 5$ V, $T_A = 25°$C.

‡ Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample-and-hold techniques are preferable to minimize internal chip heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output can raise the chip temperature well above normal and cause invalid readings in other parametric tests. In any sequence of parameter tests, $I_{OS}$ tests should be performed last.

§ Per TTL-driven input ($V_{IN} = 3.4$ V); all other inputs at $V_{CC}$ or GND

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (continued)

| PARAMETER | TEST CONDITIONS | | | CY54FCT574T | | | CY74FCT574T | | | UNIT |
|---|---|---|---|---|---|---|---|---|---|---|
| | | | | MIN | TYP† | MAX | MIN | TYP† | MAX | |
| $I_{CCD}$¶ | $V_{CC}$ = 5.5 V, Outputs open, One bit switching at 50% duty cycle, $\overline{OE}$ = GND, $V_{IN} \leq 0.2$ V or $V_{IN} \geq V_{CC} - 0.2$ V | | | | 0.06 | 0.12 | | | | mA/ MHz |
| | $V_{CC}$ = 5.25 V, Outputs open, One bit switching at 50% duty cycle, $\overline{OE}$ = GND, $V_{IN} \leq 0.2$ V or $V_{IN} \geq V_{CC} - 0.2$ V | | | | | | | 0.06 | 0.12 | |
| $I_C$ | $V_{CC}$ = 5.5 V, $f_0$ = 10 MHz, Outputs open, $\overline{OE}$ = GND | One bit switching at $f_1$ = 5 MHz at 50% duty cycle | $V_{IN} \leq 0.2$ V or $V_{IN} \geq V_{CC} - 0.2$ V | | 0.7 | 1.4 | | | | mA |
| | | | $V_{IN}$ = 3.4 V or GND | | 1.2 | 3.4 | | | | |
| | | Eight bits switching at $f_1$ = 2.5 MHz at 50% duty cycle | $V_{IN} \leq 0.2$ V or $V_{IN} \geq V_{CC} - 0.2$ V | | 1.6 | 3.2‖ | | | | |
| | | | $V_{IN}$ = 3.4 V or GND | | 3.9 | 12.2‖ | | | | |
| | $V_{CC}$ = 5.25 V, $f_0$ = 10 MHz, Outputs open, $\overline{OE}$ = GND | One bit switching at $f_1$ = 5 MHz at 50% duty cycle | $V_{IN} \leq 0.2$ V or $V_{IN} \geq V_{CC} - 0.2$ V | | | | | 0.7 | 1.4 | |
| | | | $V_{IN}$ = 3.4 V or GND | | | | | 1.2 | 3.4 | |
| | | Eight bits switching at $f_1$ = 2.5 MHz at 50% duty cycle | $V_{IN} \leq 0.2$ V or $V_{IN} \geq V_{CC} - 0.2$ V | | | | | 1.6 | 3.2‖ | |
| | | | $V_{IN}$ = 3.4 V or GND | | | | | 3.9 | 12.2‖ | |
| $C_i$ | | | | 5 | 10 | | 5 | 10 | | pF |
| $C_o$ | | | | 9 | 12 | | 9 | 12 | | pF |

† Typical values are at $V_{CC}$ = 5 V, $T_A$ = 25°C.
¶ This parameter is derived for use in total power-supply calculations.
# $I_C$ = $I_{CC} + \Delta I_{CC} \times D_H \times N_T + I_{CCD}(f_0/2 + f_1 \times N_1)$
Where:
$I_C$ = Total supply current
$I_{CC}$ = Power-supply current with CMOS input levels
$\Delta I_{CC}$ = Power-supply current for a TTL high input ($V_{IN}$ = 3.4 V)
$D_H$ = Duty cycle for TTL inputs high
$N_T$ = Number of TTL inputs at $D_H$
$I_{CCD}$ = Dynamic current caused by an input transition pair (HLH or LHL)
$f_0$ = Clock frequency for registered devices, otherwise zero
$f_1$ = Input signal frequency
$N_1$ = Number of inputs changing at $f_1$
All currents are in milliamperes and all frequencies are in megahertz.
‖ Values for these conditions are examples of the $I_{CC}$ formula.

**TEXAS INSTRUMENTS**

**timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)**

| | | CY54FCT574T | | CY54FCT574AT | | CY54FCT574CT | | UNIT |
|---|---|---|---|---|---|---|---|---|
| | | MIN | MAX | MIN | MAX | MIN | MAX | |
| $t_w$ | Pulse duration, CP high or low | 7 | | 6 | | 6 | | ns |
| $t_{su}$ | Setup time, data before CP↑ | 2 | | 2 | | 2 | | ns |
| $t_h$ | Hold time, data after CP↑ | 1.5 | | 1.5 | | 1.5 | | ns |

**timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)**

| | | CY74FCT574T | | CY74FCT574AT | | CY74FCT574CT | | UNIT |
|---|---|---|---|---|---|---|---|---|
| | | MIN | MAX | MIN | MAX | MIN | MAX | |
| $t_w$ | Pulse duration, CP high or low | 7 | | 5 | | 5 | | ns |
| $t_{su}$ | Setup time, data before CP↑ | 2 | | 2 | | 2 | | ns |
| $t_h$ | Hold time, data after CP↑ | 1.5 | | 1.5 | | 1.5 | | ns |

**switching characteristics over operating free-air temperature range (see Figure 1)**
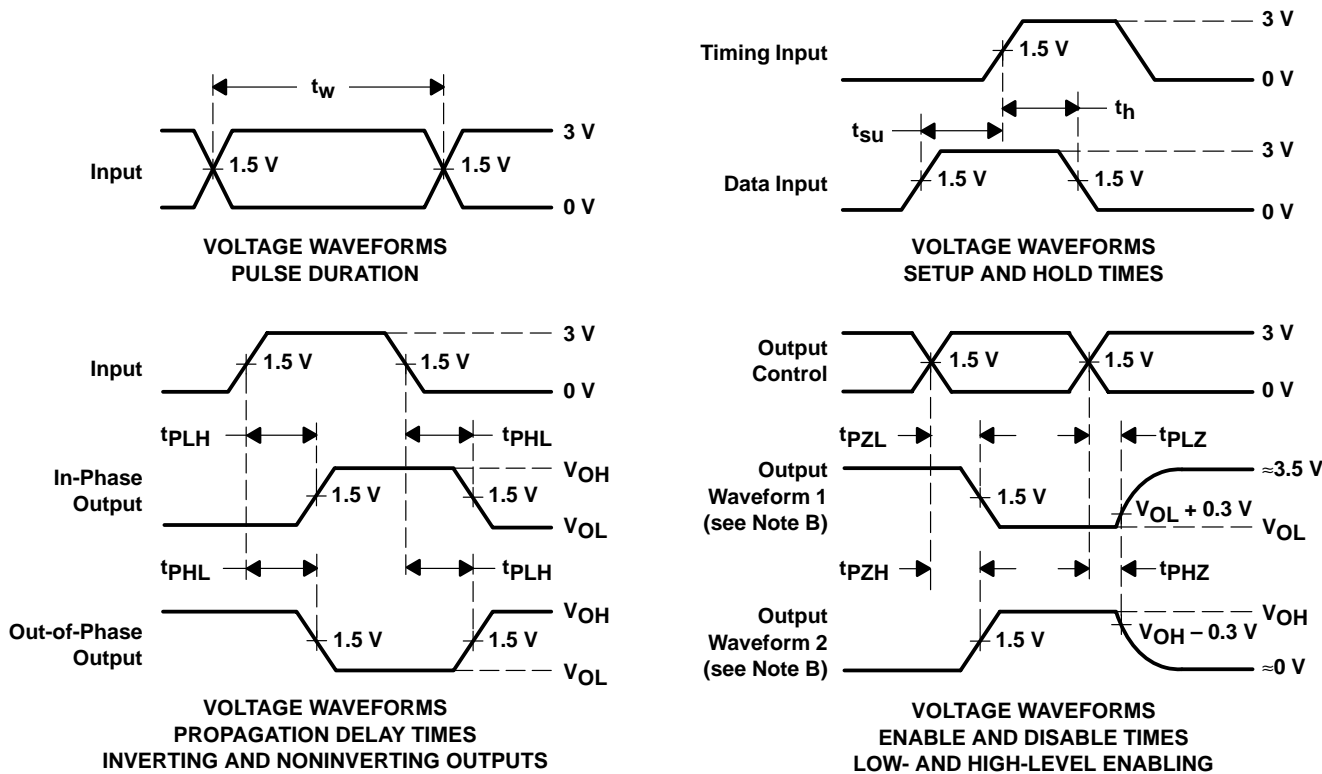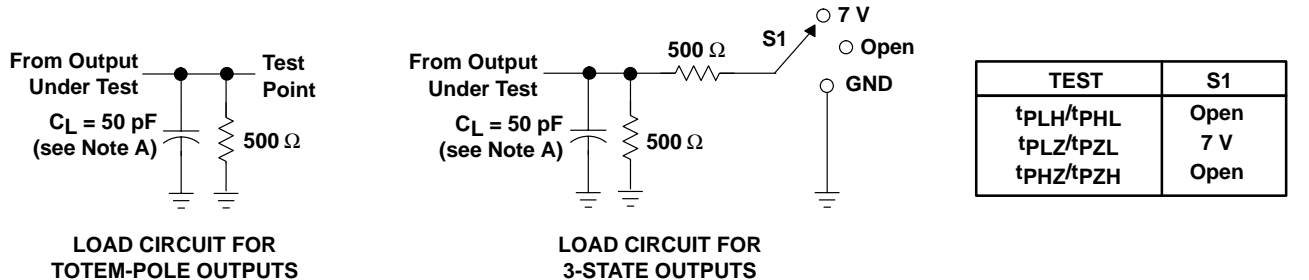
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | CY54FCT574T | | CY54FCT574AT | | CY54FCT574CT | | UNIT |
|---|---|---|---|---|---|---|---|---|---|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | |
| $t_{PLH}$ | CP | O | 2 | 11 | 2 | 7.2 | 2 | 6.2 | ns |
| $t_{PHL}$ | | | 2 | 11 | 2 | 7.2 | 2 | 6.2 | |
| $t_{PZH}$ | $\overline{OE}$ | O | 1.5 | 14 | 1.5 | 7.5 | 1.5 | 6.2 | ns |
| $t_{PZL}$ | | | 1.5 | 14 | 1.5 | 7.5 | 1.5 | 6.2 | |
| $t_{PHZ}$ | $\overline{OE}$ | O | 1.5 | 8 | 1.5 | 6.5 | 1.5 | 5.7 | ns |
| $t_{PLZ}$ | | | 1.5 | 8 | 1.5 | 6.5 | 1.5 | 5.7 | |

**switching characteristics over operating free-air temperature range (see Figure 1)**

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | CY74FCT574T | | CY74FCT574AT | | CY74FCT574CT | | UNIT |
|---|---|---|---|---|---|---|---|---|---|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | |
| $t_{PLH}$ | CP | O | 2 | 10 | 2 | 6.5 | 2 | 5.2 | ns |
| $t_{PHL}$ | | | 2 | 10 | 2 | 6.5 | 2 | 5.2 | |
| $t_{PZH}$ | $\overline{OE}$ | O | 1.5 | 12.5 | 1.5 | 6.5 | 1.5 | 5.5 | ns |
| $t_{PZL}$ | | | 1.5 | 12.5 | 1.5 | 6.5 | 1.5 | 5.5 | |
| $t_{PHZ}$ | $\overline{OE}$ | O | 1.5 | 8 | 1.5 | 5.5 | 1.5 | 5 | ns |
| $t_{PLZ}$ | | | 1.5 | 8 | 1.5 | 5.5 | 1.5 | 5 | |

## PARAMETER MEASUREMENT INFORMATION

**From Output Under Test**
$C_L$ = 50 pF (see Note A)

**Test Point**
500 $\Omega$

**LOAD CIRCUIT FOR TOTEM-POLE OUTPUTS**

**From Output Under Test**
$C_L$ = 50 pF (see Note A)
500 $\Omega$
500 $\Omega$
S1
○ 7 V
○ Open
○ GND

**LOAD CIRCUIT FOR 3-STATE OUTPUTS**

| TEST | S1 |
|---|---|
| $t_{PLH}$/$t_{PHL}$ | Open |
| $t_{PLZ}$/$t_{PZL}$ | 7 V |
| $t_{PHZ}$/$t_{PZH}$ | Open |

**Input**
$t_W$
1.5 V     1.5 V
3 V
0 V

**VOLTAGE WAVEFORMS PULSE DURATION**

**Timing Input**
1.5 V
3 V
0 V

$t_h$
$t_{su}$

**Data Input**
1.5 V     1.5 V
3 V
0 V

**VOLTAGE WAVEFORMS SETUP AND HOLD TIMES**

**Input**
1.5 V     1.5 V
3 V
0 V

$t_{PLH}$     $t_{PHL}$

**In-Phase Output**
1.5 V     1.5 V
$V_{OH}$
$V_{OL}$

$t_{PHL}$     $t_{PLH}$

**Out-of-Phase Output**
1.5 V     1.5 V
$V_{OH}$
$V_{OL}$

**VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES INVERTING AND NONINVERTING OUTPUTS**

**Output Control**
1.5 V     1.5 V
3 V
0 V

$t_{PZL}$     $t_{PLZ}$

**Output Waveform 1 (see Note B)**
1.5 V
≈3.5 V
$V_{OL}$ + 0.3 V
$V_{OL}$

$t_{PZH}$     $t_{PHZ}$

**Output Waveform 2 (see Note B)**
1.5 V
$V_{OH}$
$V_{OH}$ – 0.3 V
≈0 V

**VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING**

NOTES: A. $C_L$ includes probe and jig capacitance.
   B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
      Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   C. The outputs are measured one at a time with one input transition per measurement.

**Figure 1. Load Circuit and Voltage Waveforms**

## PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|---|---|---|---|---|---|---|---|---|---|---|---|
| 5962-9222203M2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962-9222203M2A CY54FCT 574ATLMB | Samples |
| 5962-9222203MRA | ACTIVE | CDIP | J | 20 | 1 | TBD | Call TI | N / A for Pkg Type | -55 to 125 | 5962-9222203MRA | Samples |
| 5962-9222205MRA | ACTIVE | CDIP | J | 20 | 1 | TBD | Call TI | N / A for Pkg Type | -55 to 125 | 5962-9222205MRA | Samples |
| CY54FCT574ATLMB | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 5962-9222203M2A CY54FCT 574ATLMB | Samples |
| CY74FCT574ATQCT | ACTIVE | SSOP | DBQ | 20 | 2500 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | FCT574A | Samples |
| CY74FCT574ATSOC | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT574A | Samples |
| CY74FCT574CTQCT | ACTIVE | SSOP | DBQ | 20 | 2500 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | FCT574C | Samples |
| CY74FCT574CTSOC | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT574C | Samples |
| CY74FCT574TQCT | ACTIVE | SSOP | DBQ | 20 | 2500 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | FCT574 | Samples |
| CY74FCT574TQCTG4 | ACTIVE | SSOP | DBQ | 20 | 2500 | Green (RoHS & no Sb/Br) | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | FCT574 | Samples |
| CY74FCT574TSOC | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT574 | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

**(2)** **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

**(3)** MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**(4)** There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

**(5)** Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

**(6)** Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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# PACKAGE MATERIALS INFORMATION

## TAPE AND REEL INFORMATION

**REEL DIMENSIONS**

**TAPE DIMENSIONS**

| | |
|---|---|
| A0 | Dimension designed to accommodate the component width |
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**

*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---|---|---|---|---|---|---|---|---|---|---|---|---|
| CY74FCT574ATQCT | SSOP | DBQ | 20 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| CY74FCT574CTQCT | SSOP | DBQ | 20 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| CY74FCT574TQCT | SSOP | DBQ | 20 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |

**TAPE AND REEL BOX  DIMENSIONS**



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---|---|---|---|---|---|---|---|
| CY74FCT574ATQCT | SSOP | DBQ | 20 | 2500 | 367.0 | 367.0 | 38.0 |
| CY74FCT574CTQCT | SSOP | DBQ | 20 | 2500 | 367.0 | 367.0 | 38.0 |
| CY74FCT574TQCT | SSOP | DBQ | 20 | 2500 | 367.0 | 367.0 | 38.0 |

# IMPORTANT NOTICE AND DISCLAIMER